

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	MR. LAWRENCE J. SMITH	04/10/2014
RECEIVING PARTY DATA		
Name:	BRIDGEPORT FITTINGS, INC.	
Street Address:	705 LORDSHIP BLVD.	
City:	STRATFORD	
State/Country:	CONNECTICUT	
Postal Code:	06615	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	29489144	
CORRESPONDENCE DATA		
Fax Number:	(203)261-5676	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	203-261-1234	
Email:	aaf@warefressola.com	
Correspondent Name:	WARE, FRESSOLA, MAGUIRE & BARBER LLP	
Address Line 1:	BRADFORD GREEN, BUILDING 5	
Address Line 2:	755 MAIN STREET, P O BOX 224	
Address Line 4:	MONROE, CONNECTICUT 06468	
ATTORNEY DOCKET NUMBER:	302-211.182	
NAME OF SUBMITTER:	ALFRED A. FRESSOLA	
SIGNATURE:	/Alfred A. Fressola/	
DATE SIGNED:	04/28/2014	
Total Attachments: 2		
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ASSIGNMENT AND AGREEMENT

FOR VALUE RECEIVED, I, Lawrence J. SMITH, a citizen of the United States residing at 75 Cricket Lane, Stamford, CT 06903, hereby sell, assign and transfer to **BRIDGEPORT FITTINGS, INC.**, an organization duly organized and existing under the laws of Connecticut, and having a principal place of business at 705 Lordship Blvd., Stratford, CT 06615, as assignee, and its successors, assigns and legal representatives, the entire right, title and interest, for all countries in and to certain inventions relating to improvements in a **PUSH-ON TYPE GROUNDING BUSHING**, which is described in an application for Letters Patent of the United States executed by me on even date herewith, and which is identified by Ware, Fressola, Maguire & Barber LLP as Attorney Docket No. 302-211.182 and all the rights and privileges under any and all Letters Patent that may be granted therefor.

I request that any and all patents for said inventions in all countries be issued to said assignee, its successors, assigns and legal representatives, or to such nominees as it may designate.

I agree that, when requested, I will, without charge to said assignee but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for said inventions in any and all countries and for vesting title thereto in said assignee, its successors, assigns and legal representatives or nominees.

I authorize and empower the said assignee, its successors, assigns and legal representatives or nominees, to invoke and claim for any application for patent or other form of protection for said inventions filed by it or them, the benefit of the right of priority provided by: (a) the International Convention for the Protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for it; and (b) the Patent Cooperation Treaty, as amended, or by any treaty which may henceforth be substituted for it; and to invoke and claim such right of priority without further written or oral authorization from me.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any assignment, consent to file or like document which may be required in any country for any purpose and more particularly in proof of the right of the said assignee or nominee to claim the aforesaid benefit of the right of priority provided by: (a) the International Convention for the protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for it; and (b) the Patent Cooperation Treaty, as amended, or by any treaty which may henceforth be substituted for it.

I covenant with said assignee, its successors and assigns and legal representatives, that the rights and property herein conveyed are free and clear of any encumbrance, and that I have full right to convey the same as herein expressed.

Signed at Stamford, CT USA this 10th
(city/state/country) (day)

day of April, 2014.
(month)


Lawrence J. SMITH